SPST-NO+NC (1 Form A/B) APW612_E/EH SMD-8 / DIP-8 Load Voltage:60V Load Current:400mA

Parameter	Symbol	Rating	Units	
Load Voltage	VL	60	V	
Load Current	lı.	0.4	Α	
On-Resistance	Ron	1.0 / 6.0	Ω	
I/O Breakdown Voltage	V/ıo	5000	Vrms	









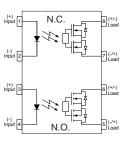
E534710



SMD-8



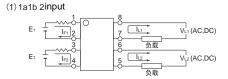
DIP-8



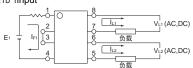
1,3. LED Anode

2,4. LED Cathode 5,6. Drain (MOS FET)

7,8. Drain (MOS FET)







APSEMI PhotoRelays

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power. While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- · Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

Applications

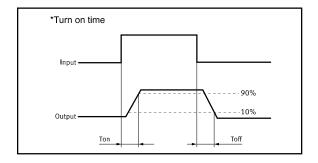
These advantages make APSEI Photorelays the ideal choice for:

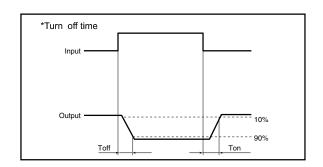
- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

0-4	Output Rating		Dealessa	Dest No.	Bashing O and	
Category	Load Voltage	Load Current	Package	Part No.	Packing Quantity	
AC/DC	201/		DIP-8	APW612E	50pcs /tube	
AC/DC	60V 400mA	SMD-8	APW612EH	1000pcs /reel		







Absolute Maximum Ratings (Ta = 25°C)

	Item	Symbol	Value	Units	Note
Continuous LED Current		IF	50	mA	
Input	Peak LED Current	IFP	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	VR	5	V	
Input Power Dissipation		Pln	75	mW	
	Load Voltage	VL	60	V(AC peak or DC)	
Output	Load Current	IL	400	mA	
	Peak Load Current	lPeak	700	mA	1ms(1 pulse)
	Output Power Dissipation	Pout	450	mW	
Total Power	Dissipation	PT	500	mW	
I/O Breakdov	vn Voltage	VI/O	5000	Vrms	RH=60%, 1min
Operating Te	emperature	TOpr	-40 to +85	-40 to +85	
Storage Tem	perature	TStg	-40 to +100	-40 to +100	
Pin Soldering	g Temperature	TSol	260	260	10 sec max.

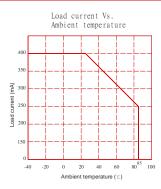
Electrical Characteristics (Ta = 25°C)

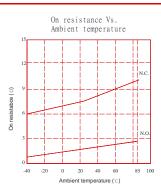
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
	LED Forward Voltage	VF		1.2	1.4	V	IF=10mA
Input	Operation LED Current	IF On		0.5	5.0	mA	
	Recovery LED Current	IF Off		0.35	0.5	mA	
	Recovery LED Voltage	VF Off	0.5			V	
	On-Resistance	ROn		1(N.O.)	1.4(N.O.)	Ω	IF=5mA (N.O.) IF=0mA (N.C) IL=100mA Time to flow is within 1 sec.
Output				6(N.C.)	10(N.C.)		Time to now is within 1 sec.
	Off-State Leakage Current	ILeak		1	10	uA	IF=0mA (N.O.) IF=5mA (N.C) VL= Rating
	Output Capacitance	COut		150		pF	IF=5mA,VL=0, f=1MHz
Transmis sion	Turn-On Time	TOn		0.23(N.O.)	0.5(N.O.)	ms	
				0.2(N.C.)	1.0(N.C.)		IF=5mA, IL=50mA
	Turn-Off Time	TOff		0.03(N.O.)	0.2(N.O.)	ms	
				0.5(N.C.)	3.0(N.C.)		
Coupled	I/O Isolation Resistance	RI/O	10 ¹⁰			Ω	DC500V
Coupled	I/O Capacitance	CI/O		0.8		pF	f=1MHz

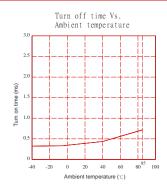
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

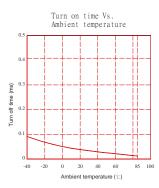


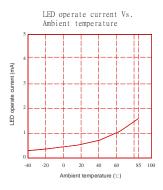
Engineering Data

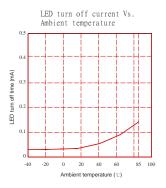


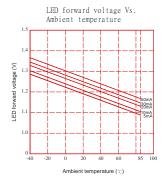


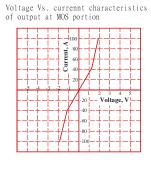


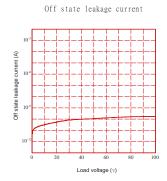


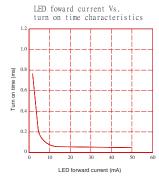


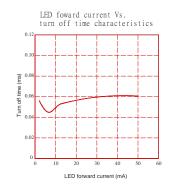


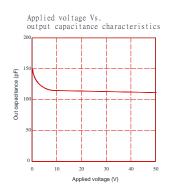














Dimensions and DIP-8 Package

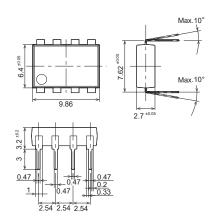
Linit: mm

LOGO APW PART NO. YY=YEAR WW=WEEK APW 612 XXXXX

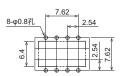
Lable



Through hole terminal type



PC board pattern (Bottom view)



DIP Tape dimensions Unit: mm

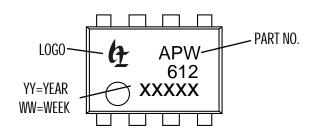
Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.





Dimensions and SMD-8 Package Unit: mm

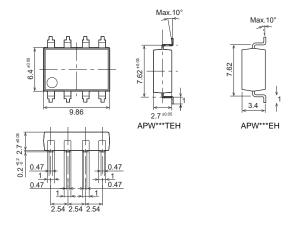
Marking



Lable



Surface mount terminal type

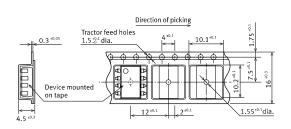


Recommended mounting pad (Top view)

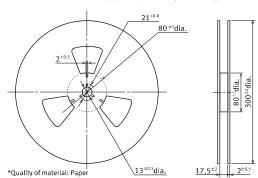


Tape dimensions (tape reel)

Tape dimensions (Unit: mm)



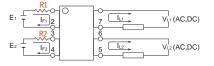
Dimensions of paper tape reel (Unit: mm)





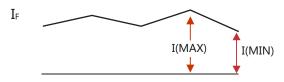
Using Methods

Examples of resistance value to control LED forward current (IF=5mA)



E1 E2	R1 R2(Approx)			
3.3V	300 Ω			
5.0V	600 Ω			
12V	1.9KΩ			
24V	4.1K Ω			

LED forward current must be more than 5mA, at I(MIN), and less than 30mA, at I(MAX).



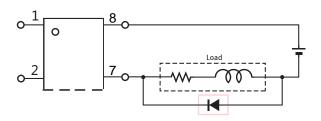
Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

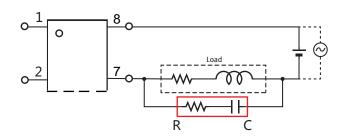
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

Protection Circuit

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.



CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.



When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.



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